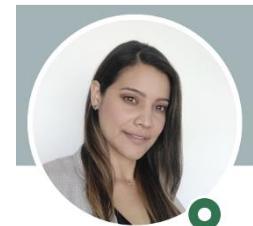


MICRO 423 : ADVANCED ADDITIVE MANUFACTURING TECHNOLOGIES

**3D printing using continuous wave light
(single photon absorption)**

Prof. Christophe Moser

Maria Alvarez Castaño
maria.alvarezcastano@epfl.ch

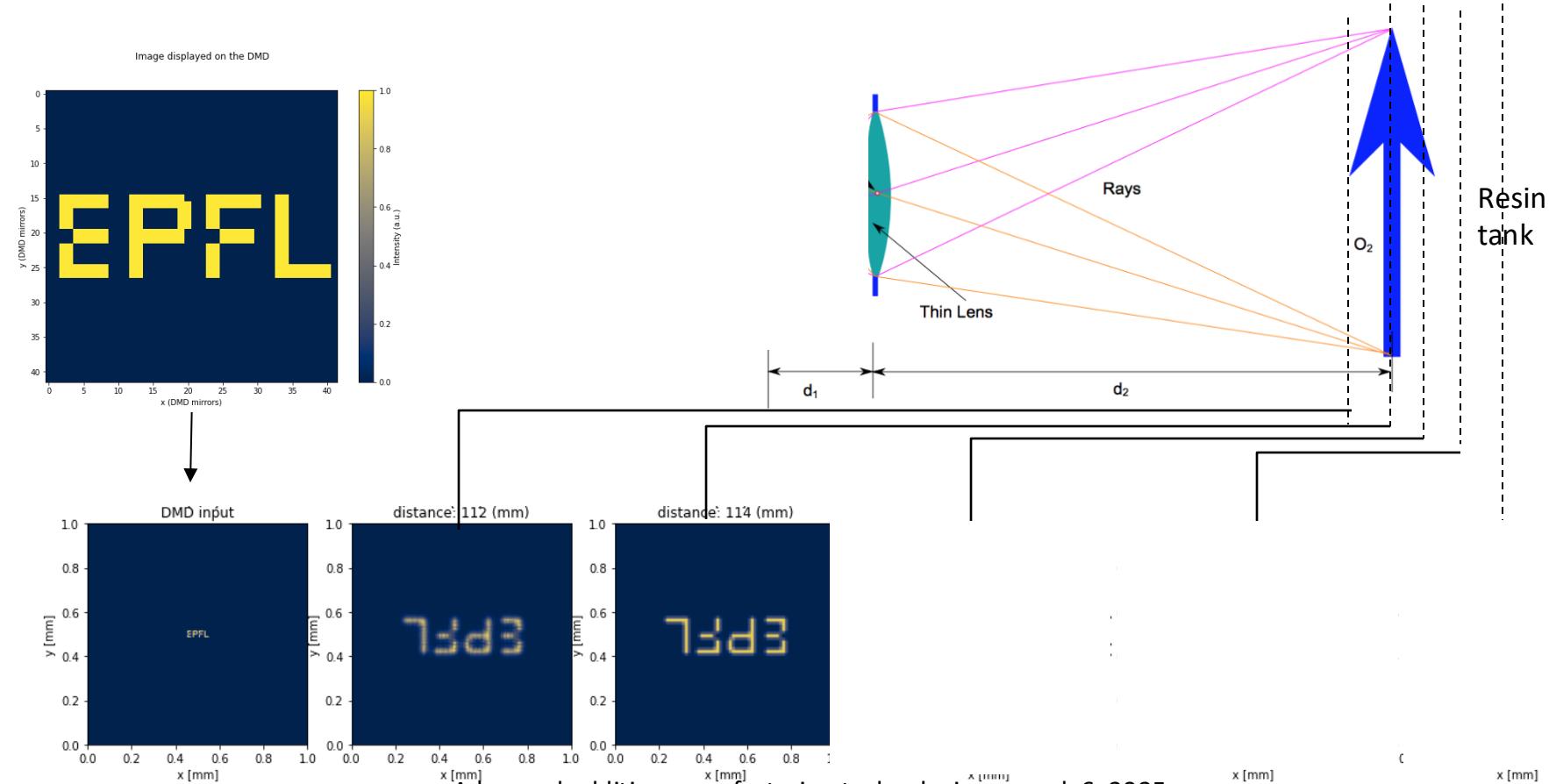


Modules of the 2025 course

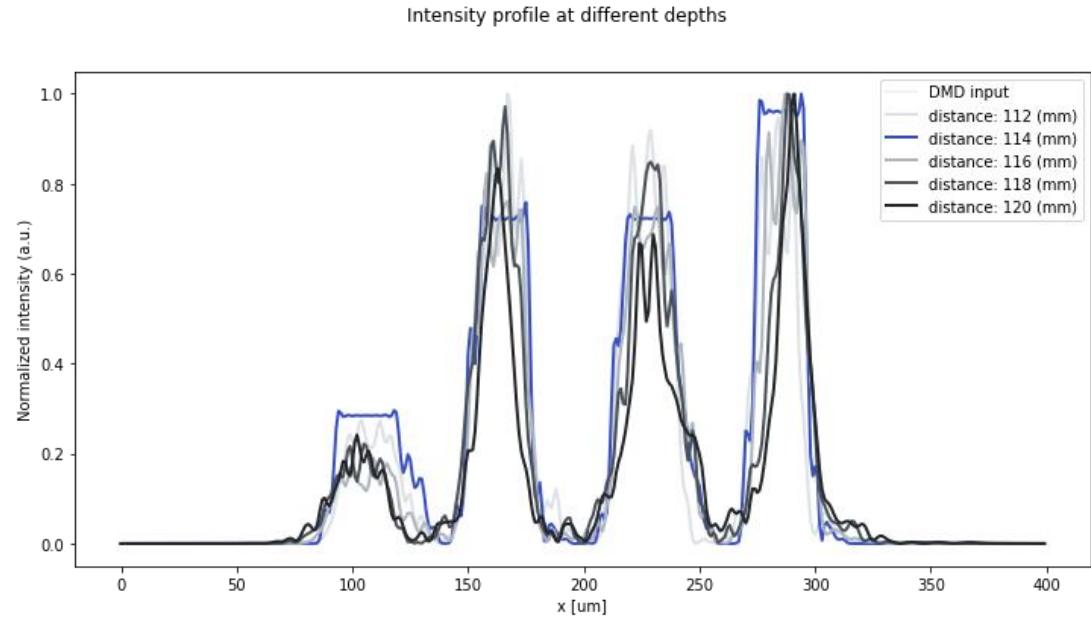
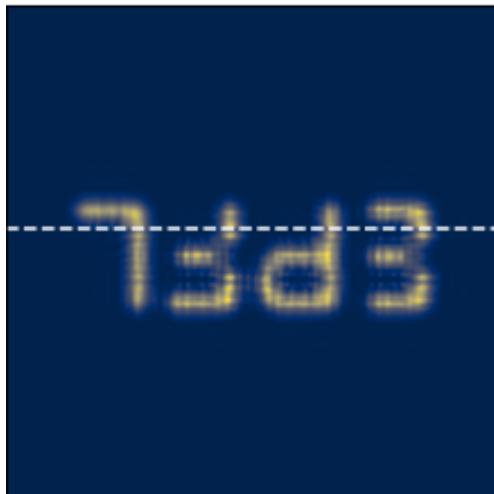
Topics covered	No	Lecture/Date
VAT Photo polymerization (history) – DLP printer – light engine – part I	5	20.03.2025
DLP printer – chemical components in a photoresin – role of oxygen – CLIP method – part II	6	27.03.2025
Tomographic Volumetric Additive Manufacturing (TVAM)	7	03.04.2025
Two photon Polymerization : nanoscale printing	8	10.04.2025
Two photon Polymerization : applications	9	17.04.2025
EASTER BREAK		22.04.2025
Prof. Paul Dalton, University of Oregon: Met Electro Writing (nanoscale)	10	1.05.2025
Gari Arutinov, Holst Center for AM: Mass transfer of microcomponents	11	08.05.2025
Julian Schneider: Scrona	12	15.05.2025
Patrizia Richner: Sonova (hearing aids). //	13	22.05.2025
Design Competition		

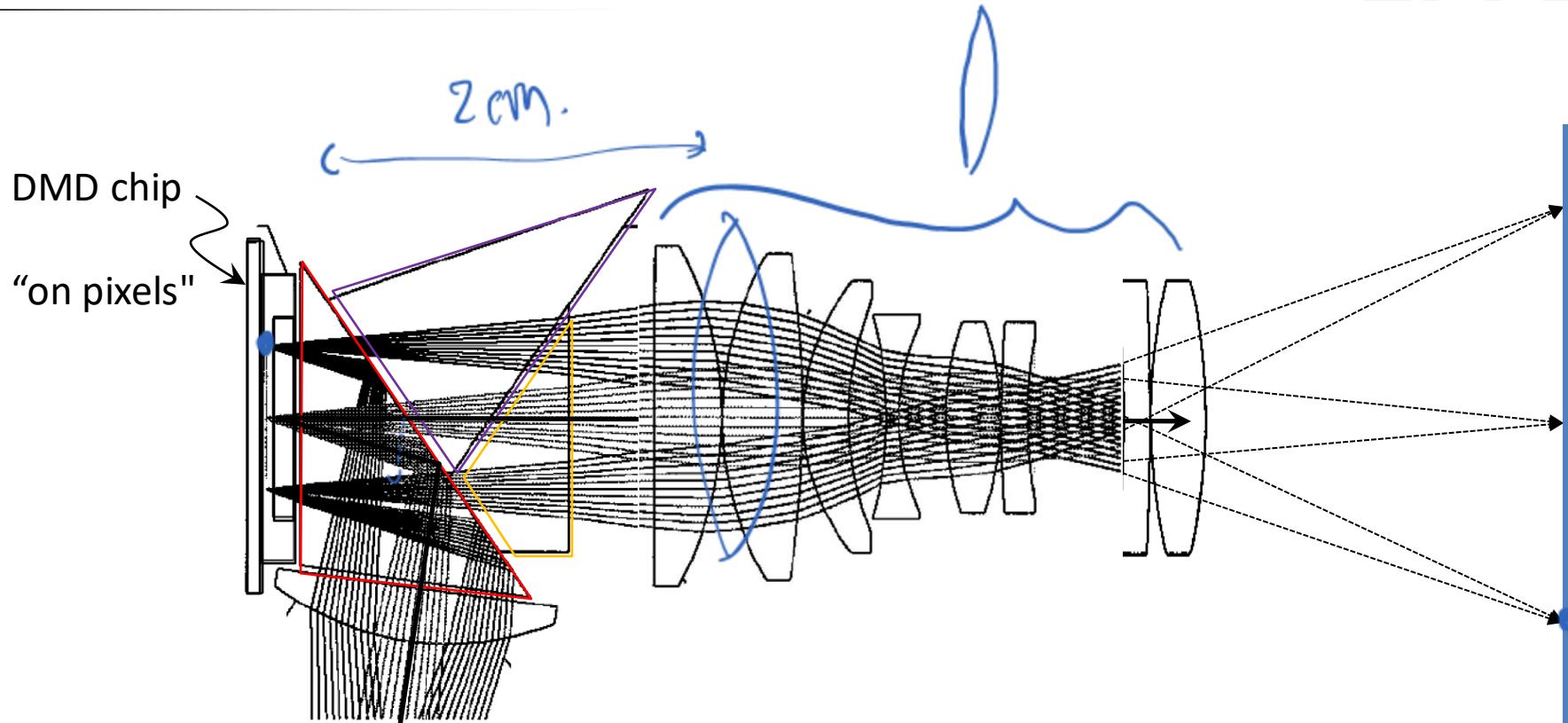
QUIZZ #2

Review: Projection in a DLP printer

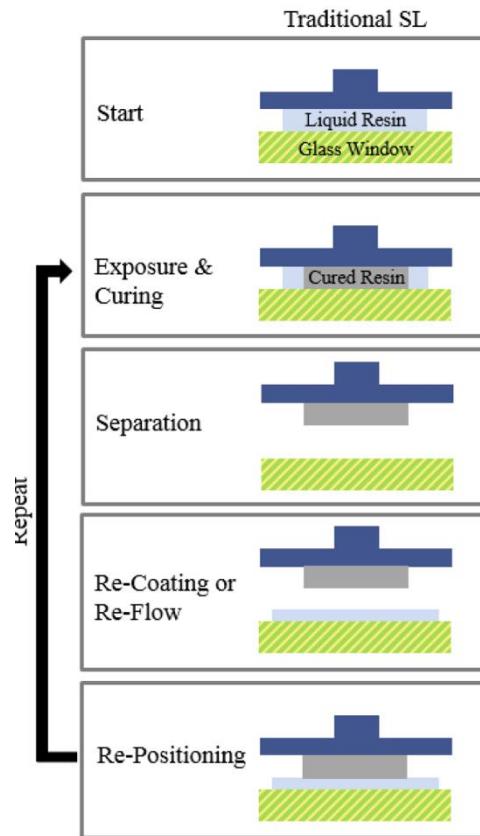
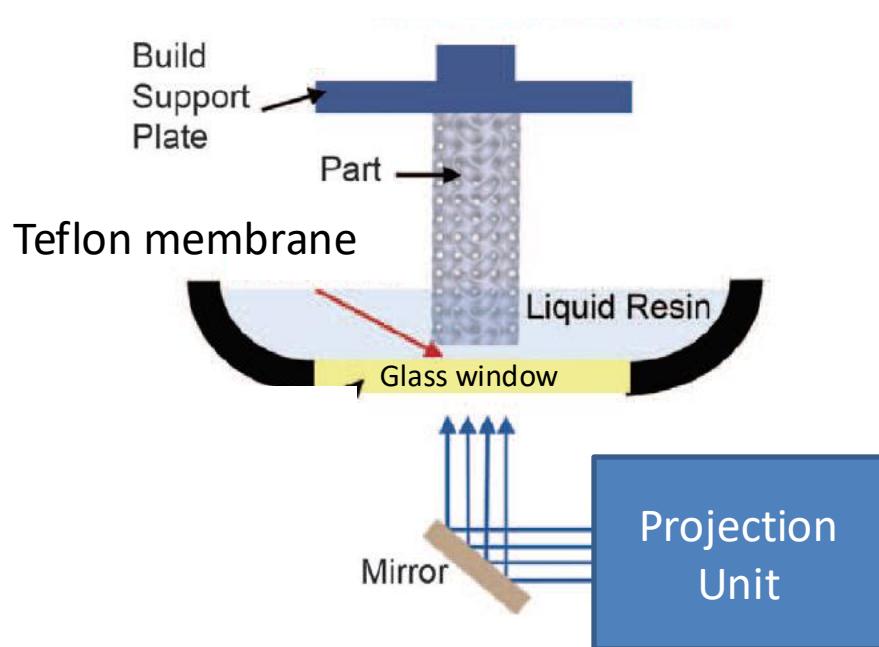


Projecting an image at the wrong plane compromises contrast

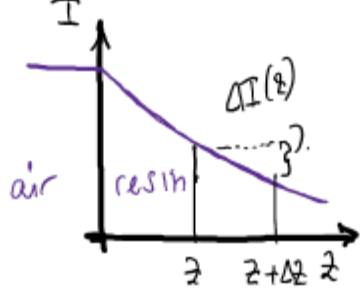




Review: DLP 3D printing



Light absorption defines layer resolution



• $I(z) = I_0 e^{-\alpha z}$: intensity of light (^{Power}_{unit area}) at depth z in resin

• $\Delta I(z) = I(z) - I(z + \Delta z)$ absorbed light intensity between z and $z + \Delta z$

$$= \left| \frac{dI}{dz} \right| \cdot \Delta z$$

$$= \alpha I_0 e^{-\alpha z} \cdot \Delta z$$

$$\alpha = \alpha_{PI} + \alpha_{dye}$$

• $\frac{\Delta I(z)}{\Delta z} = \alpha \cdot I_0 e^{-\alpha z}$ absorbed light intensity per unit depth
(exposure)

$D = \frac{\Delta I(z)}{\Delta z} \cdot t = \alpha \cdot t \cdot I_0 e^{-\alpha z}$ absorbed light dose per unit depth

I want to cure (i.e. solidify) a thickness of depth z_{ct} (cure thickness)

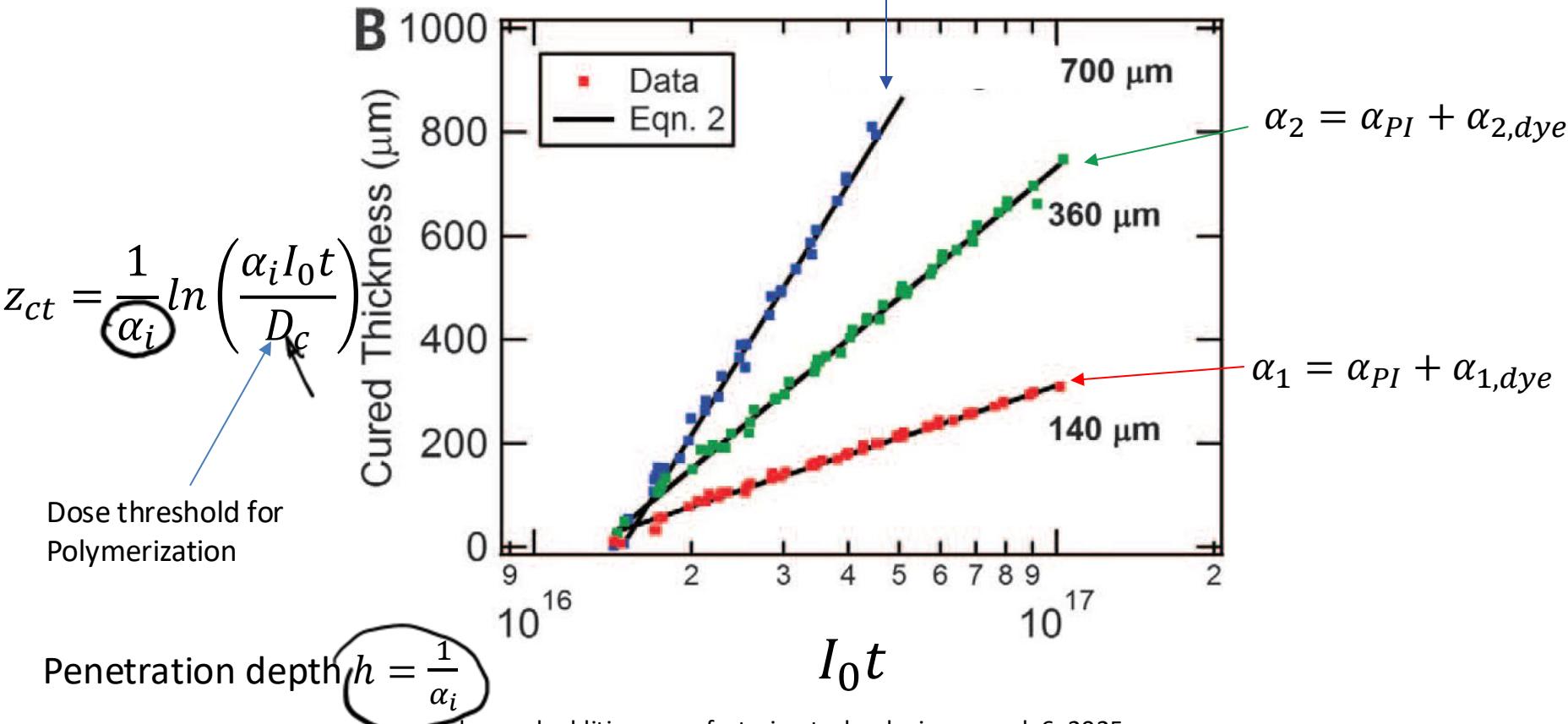
$$D_c = \alpha t_c \cdot I_0 e^{-\alpha z_{ct}} \Rightarrow \frac{D_c}{\alpha t_c \cdot I_0} = e^{-\alpha z_{ct}} \Rightarrow \ln\left(\frac{D_c}{\alpha t_c \cdot I_0}\right) = -\alpha z_{ct}$$

$$\Rightarrow z_{ct} = -\frac{1}{\alpha} \ln\left(\frac{D_c}{\alpha t_c \cdot I_0}\right) = \frac{1}{\alpha} \cdot \ln\left(\frac{\alpha t_c \cdot I_0}{D_c}\right)$$

(the usual critical dose in $\text{mJ/cm}^2 = \epsilon_c$)

Review: Curing Depth

$$\alpha_3 = \alpha_{PI} + \alpha_{3,dye}$$



RESIN PARAMETERS

FH1100 STANDARD RESIN

Appearance	Gray
Density (g/cm ³)	1.14
Viscosity (cps)	350 cps (25°C)
Critical Exposure Ec (mJ/cm ²)	12 mJ/cm ²
Penetration Depth (dp)	0.2 mm

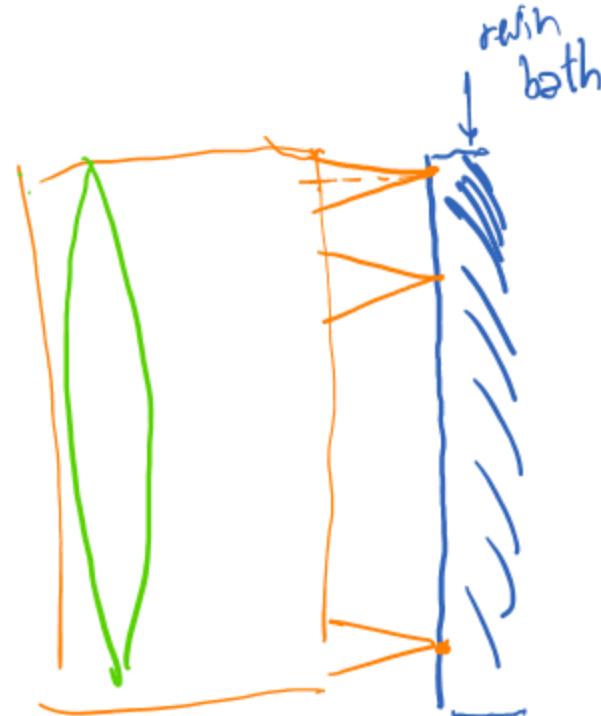
As comparison

Water has a viscosity of 1 cps at 20°C



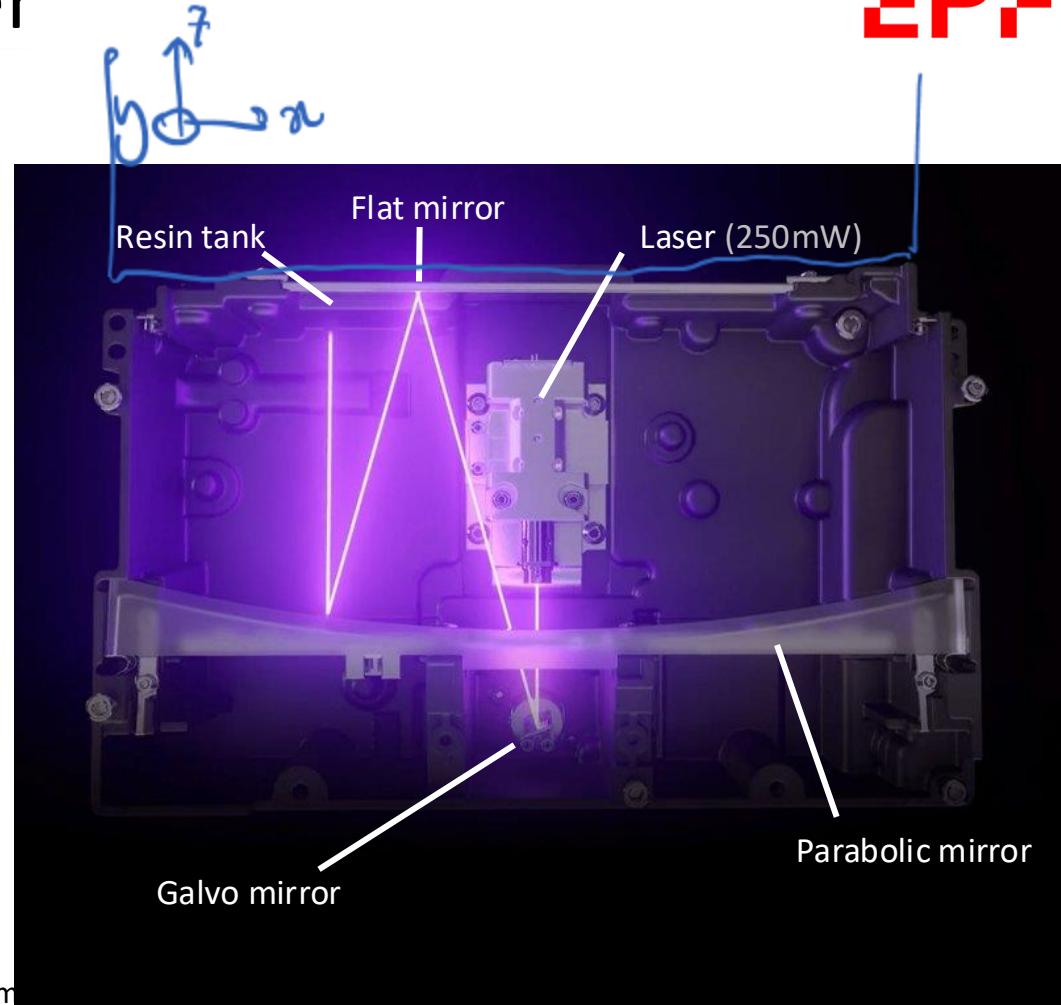
Formlabs 3 SLA printer

1 stereo lithography -

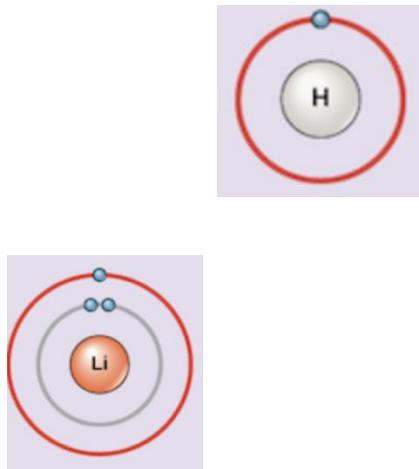


Formlabs 3 SLA printer

EPFL

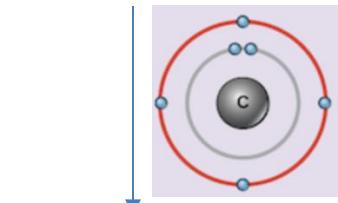


Organic chemistry basics

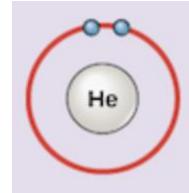


1	H Hydrogen Nonmetal
3	Li Lithium Alkali Metal
4	Be Beryllium Alkaline Earth Metal
11	Na Sodium Alkali Metal

Same reactivity in
each column



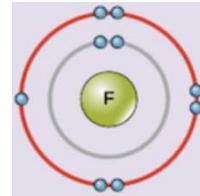
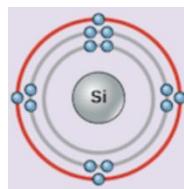
5	B Boron Metalloid
6	C Carbon Nonmetal
7	N Nitrogen Nonmetal
8	O Oxygen Nonmetal
9	F Fluorine Halogens
10	Ne Neon Noble Gas
13	Al Aluminum Post-Transition Metal
14	Si Silicon Metalloid
15	P Phosphorus Nonmetal
16	S Sulfur Nonmetal
17	Cl Chlorine Halogens
18	Ar Argon Noble Gas



Filled with $2n^2=2$

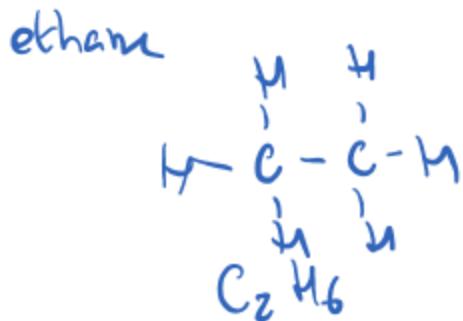
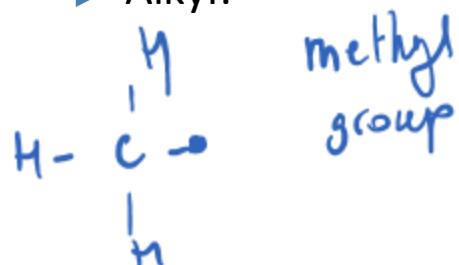
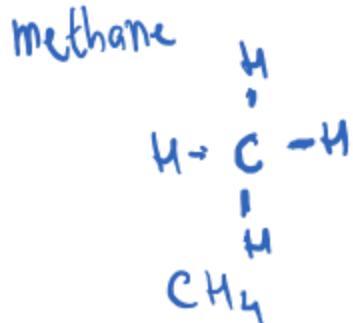
Filled with $2n^2=8$

Filled with $2n^2=18$



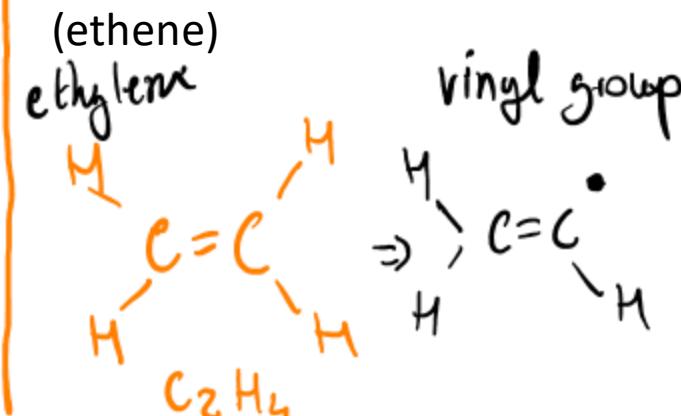
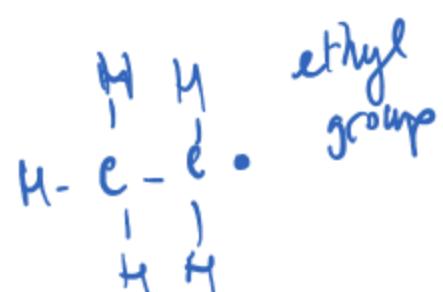
Single Carbon bonds

Alkane: → H removed → Alkyl:

(propane) C_3H_8

Double Carbon bonds

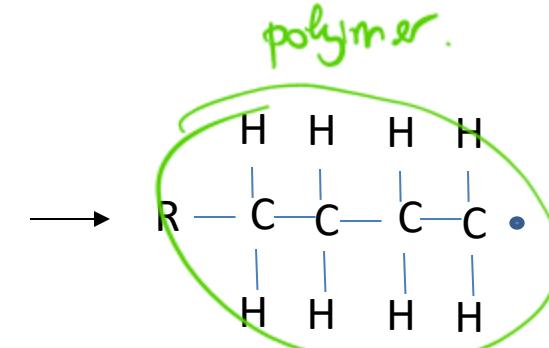
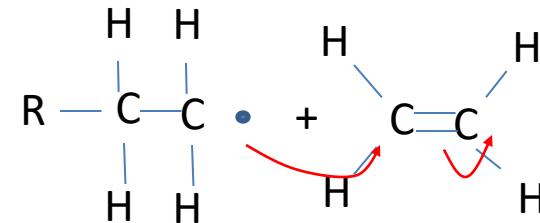
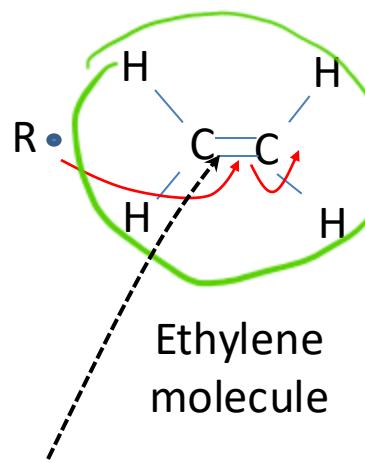
Alkene:



Radical chain Polymerization

$R\cdot$ Radical =molecule with unpaired electron

monomer.

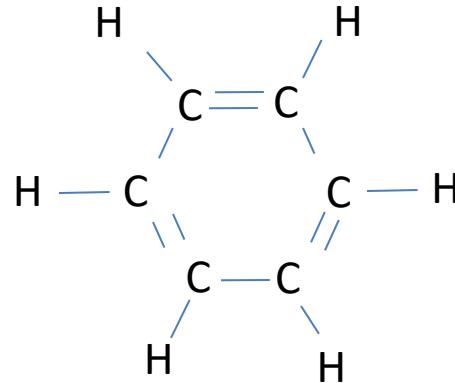


polymer chains → thermoplastics

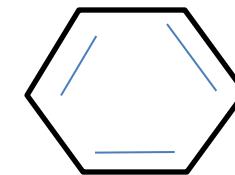
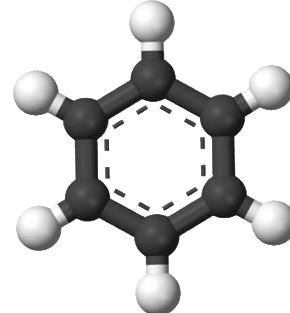
In a C=C double bond,
one of the bond is weaker
(260 kJ/mol vs 350 kJ/mol)

The Radical R^* can be created by different energy sources:
heat, light etc..

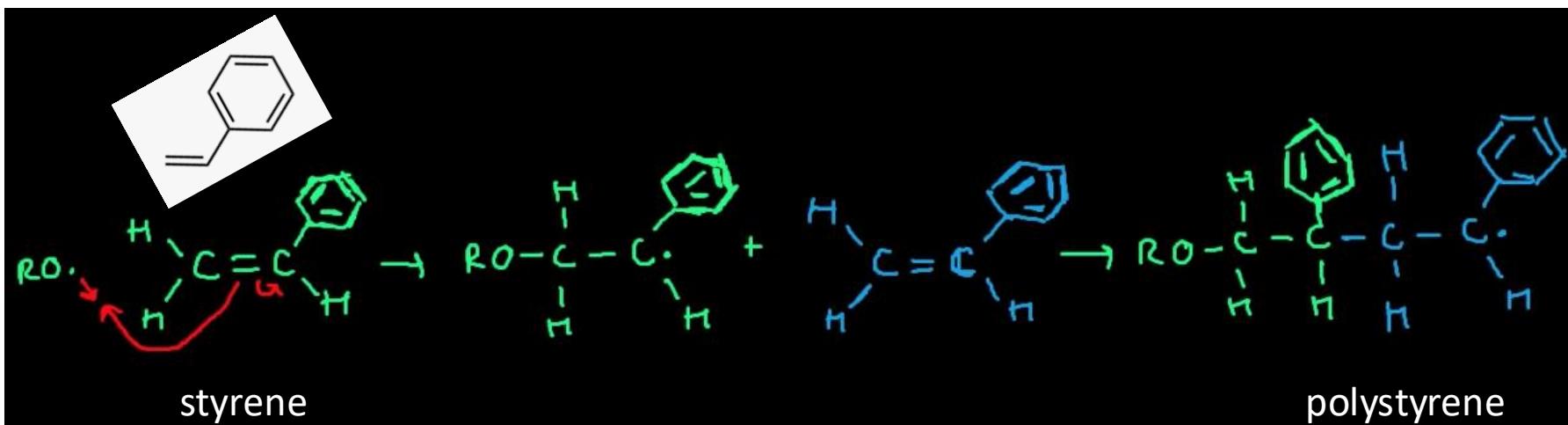
Radical chain Polymerization

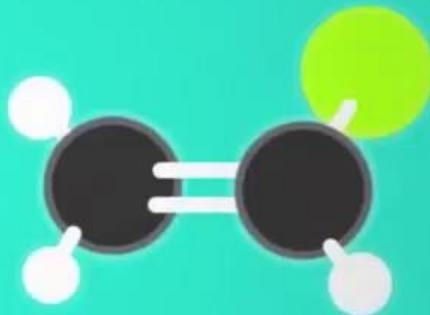
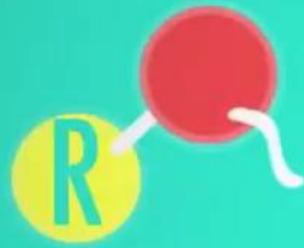


Benzene
ring



Simplified representation





Chemical components in a resin for Stereolithography

Photoinitiator

Monomers for crosslinking, mechanical strength

Absorbing dye (penetration depth)

Inhibitor (stabilizer for shelf life)

Monomer to tune viscosity



Acrylate
monomers:

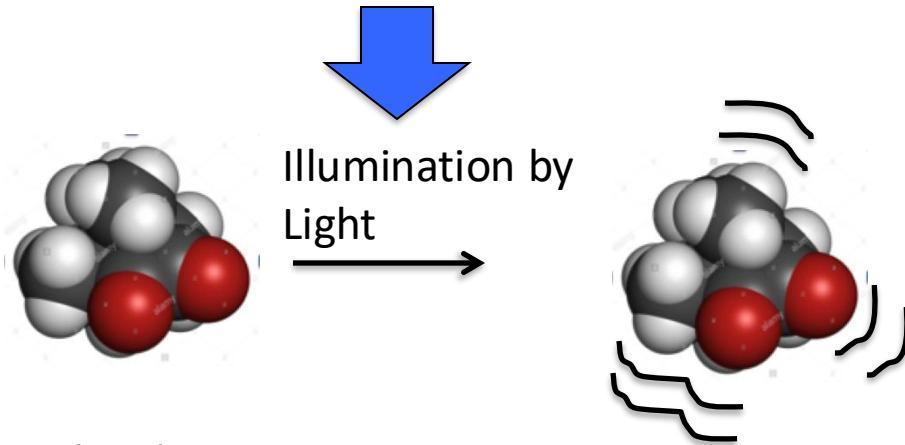
PEA: polyethylacrylate

TMPTA:

DPEPA:

IBOMA

Photo induced Radical Polymerization



Molecule
(Photoinitiator or also
called Chromophore)



Excited State: Radical

The Photoinitiator ceases
to absorb light once it is “converted”
to a radical that induces polymerization

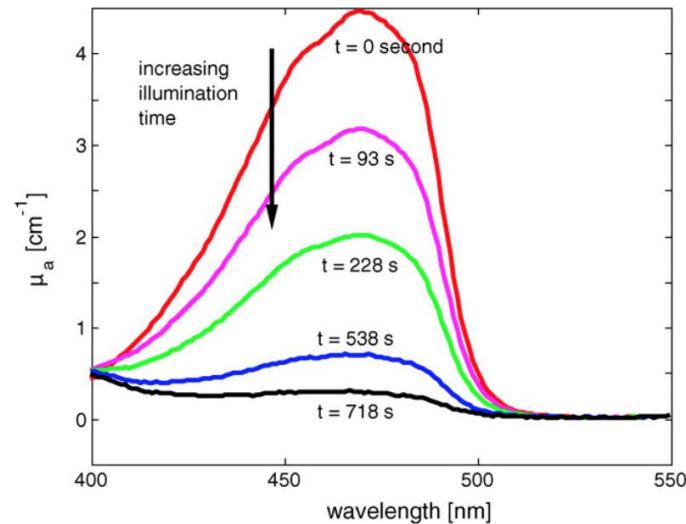
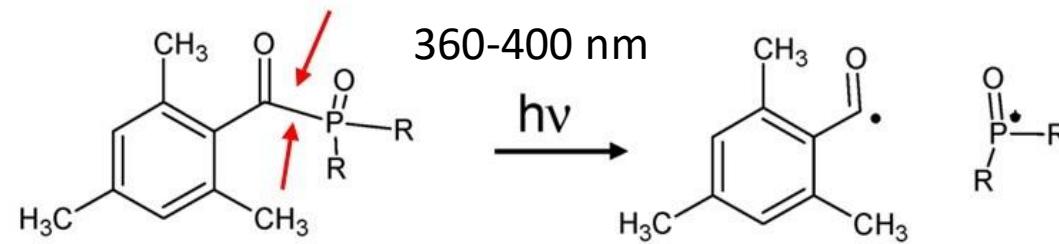
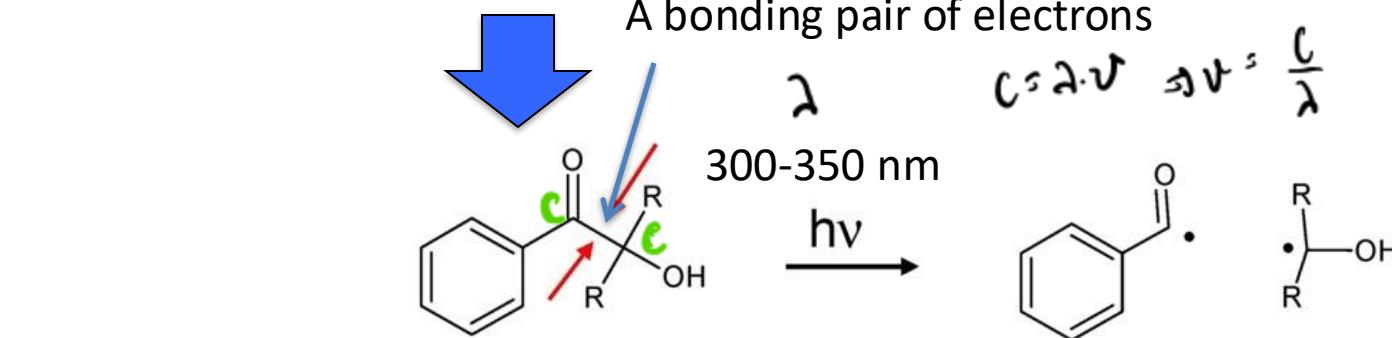


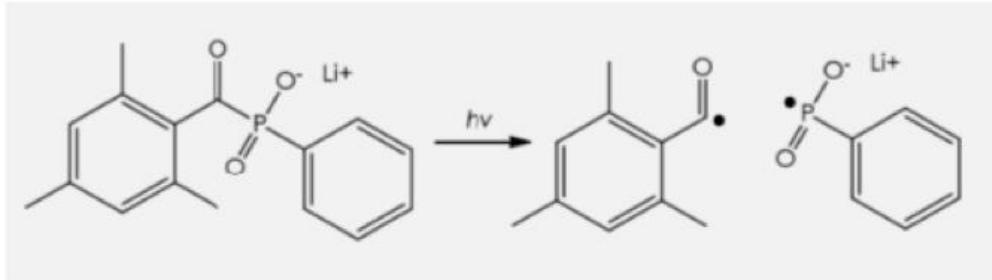
Fig. 6 – The absorption coefficient μ_a as a function of wavelength of resin with 0.7% CQ at five different illumination times for irradiance $E_{\text{total}} = 160 \text{ mW/cm}^2$

Type I photoinitiators

Light energy is used to cleave
A bonding pair of electrons

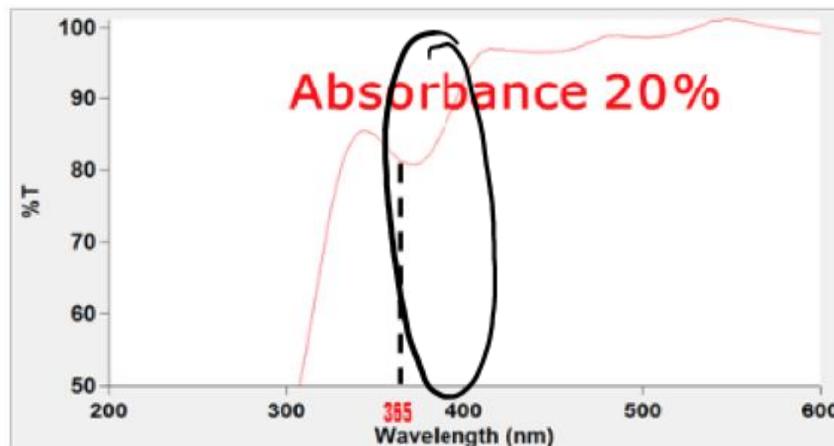


Type I photoinitiators



Lithium phenyl-2,4,6-trimethylbenzoylphosphinate (LAP)

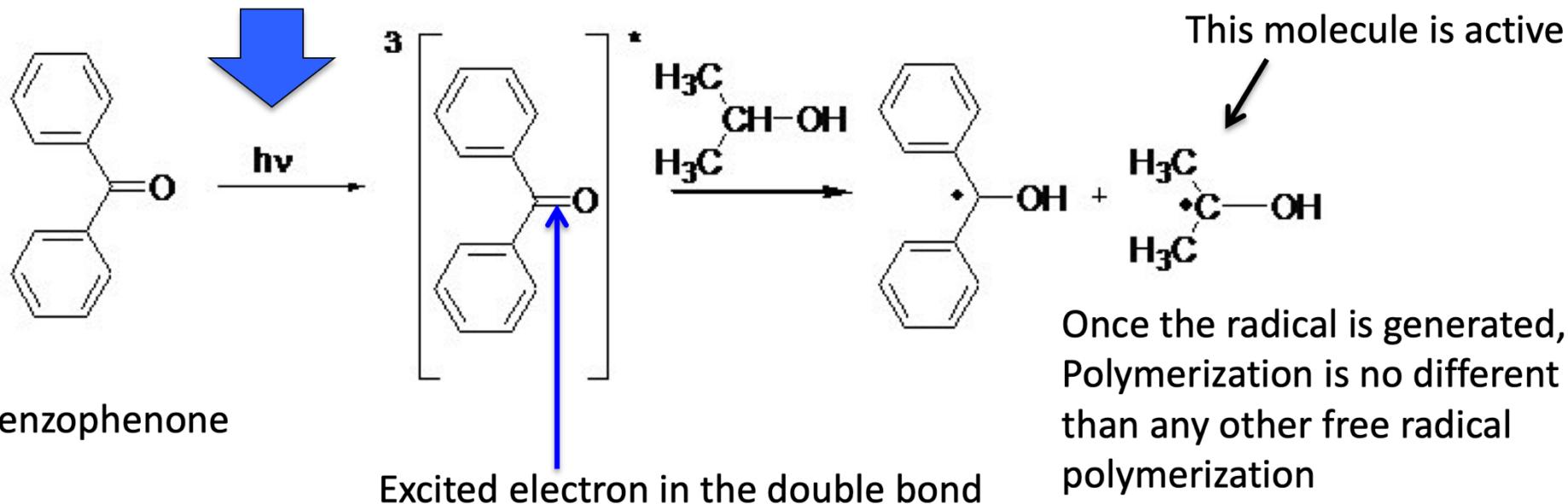
(popular PI for
Hydrogels – high solubility in
Water
30 g/liter compared to
3 mg/liter for TPO)



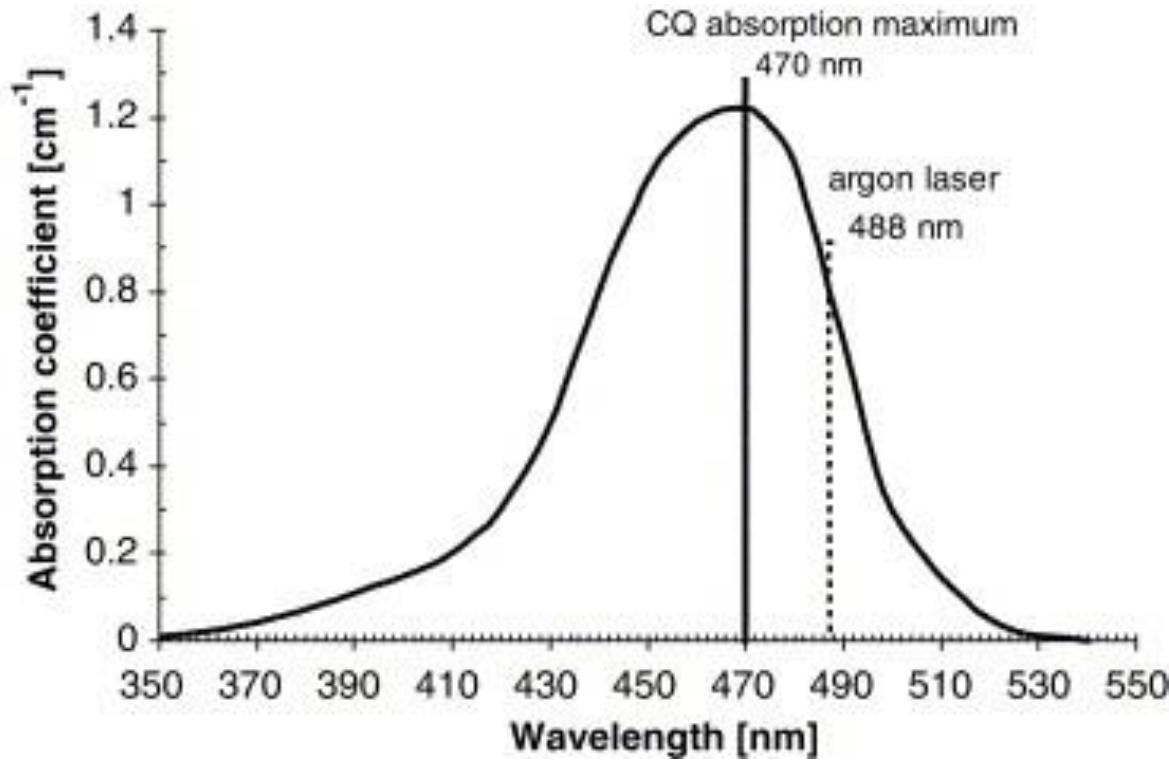
Type II photoinitiators

Less active than type I (one more step)

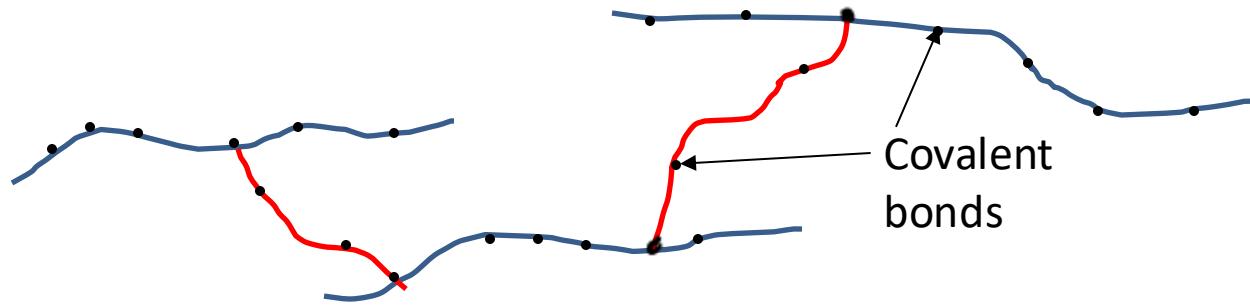
Need a co-initiator molecule to generate a Radical Reacting molecule



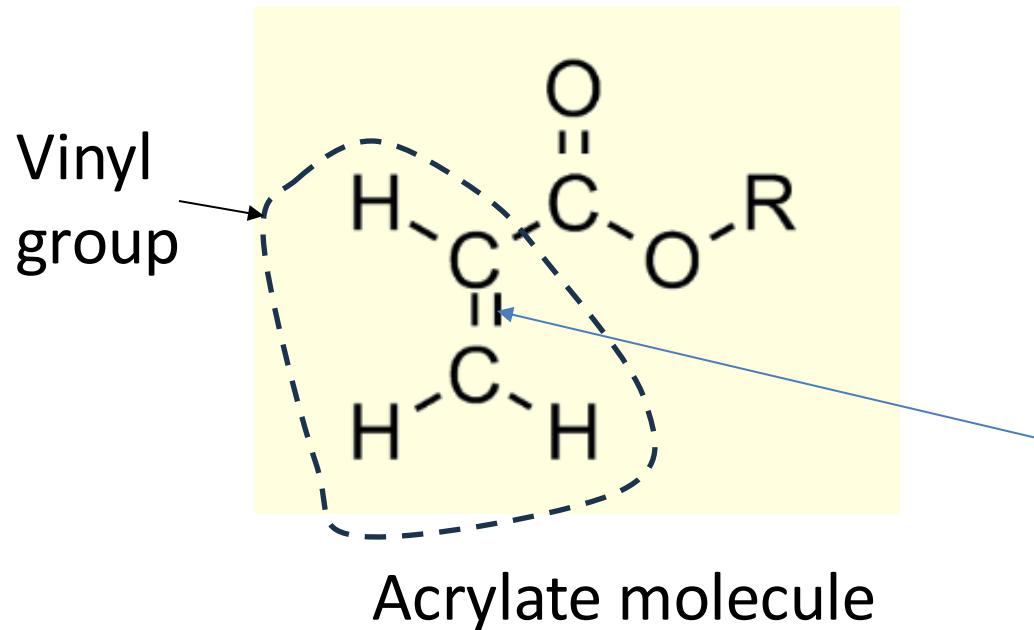
The most widely used photoinitiator in dentistry is Camphorquinone (CQ).
It is a type II Photoinitiator



Monomer



Need a monomer that can make chains via radical chain polymerization and link between chains (crosslinking) so that the curing is irreversible. The resin is called a thermoset.
It is not a thermoplastic (linear chains only, no cross linking), and thus there is no melting point for thermosets (only degradation with temperature)



R :side chain (not a Radical !!)

Double bond used for radical polymerization

Example

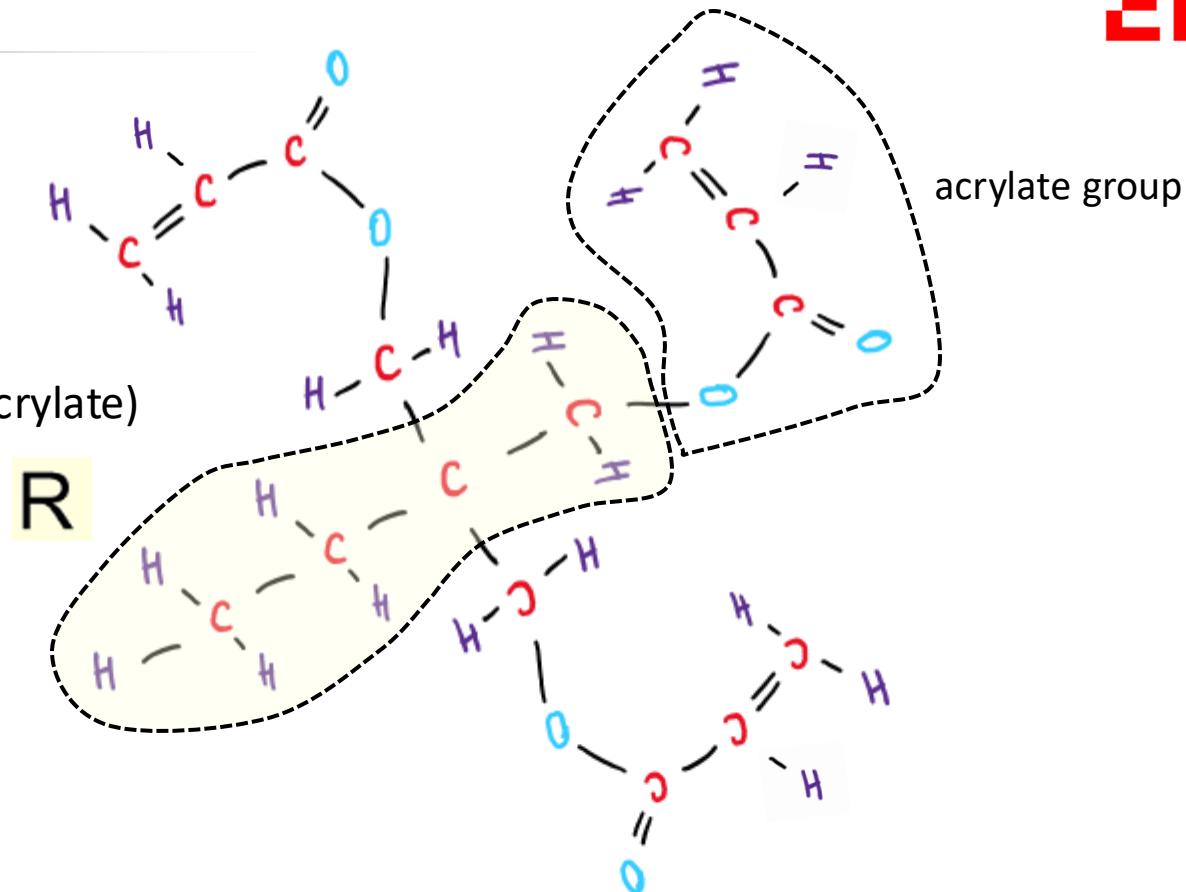
Monomer Molecule

TMPTA

(Trimethylolpropane triacrylate)

$C_{15}H_{20}O_6$

3 branches for
Cross linking



Criterion for gelation (liquid \rightarrow solid)

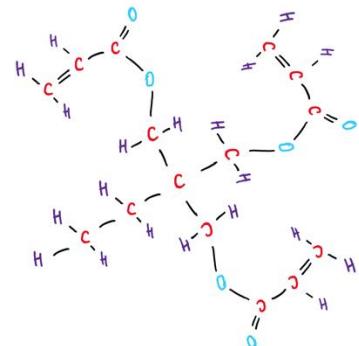
Flory criterion for gelation:

Fraction of reacted monomers $> \frac{1}{f-1} < 100\%$ f is called functionality

$f > 2$

functionality = number of reactive groups per monomer molecule that can participate in the polymerization reaction.

Example: TMPTA

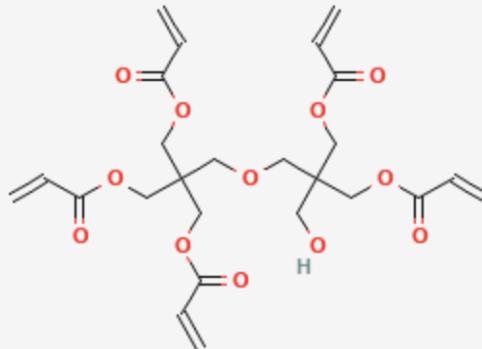


$$f = 3$$

Gelation threshold = Fraction of reacted monomers: $> \frac{1}{3-1} = 50\%$

Example

Dipentaerythritol pentaacrylate (DPEPA)



What is the gelation criterion ?

Gelation when fraction of reacted monomers $> \frac{1}{5-1} = 25\%$

From safety data sheet:

Hazard-determining components of labeling:

Urethane Dimethacrylate $\longrightarrow f = 2$

Methacrylate Monomer \longrightarrow the functionality of the monomer is not mentioned

Isobornyl methacrylate $\longrightarrow f = 1$

Phenyl bis(2,4,6-trimethylbenzoyl)-phosphine oxide \longrightarrow Photoinitiator

When a resin is a mix of monomers with different functionalities, then the average functionality \bar{f} is used in the Flory criterion:

$$\bar{f} = \frac{\sum_i x_i f_i}{\sum_i x_i}$$

x_i : fraction of component i

f_i : functionality of component i

for $\bar{f} > 2$, the functionality of the unknown monomer must be 3 or more

Role of oxygen

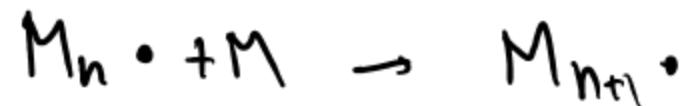
Photo-initiation



Propagation
Polymer chain growth

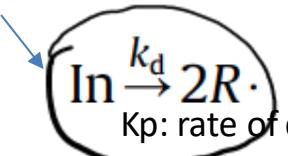


Oxygen radical
scavenging

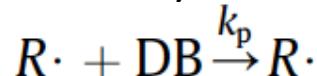


Reaction kinetics

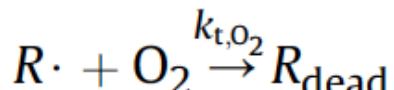
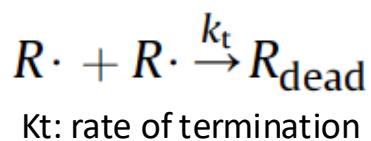
Photoinitiator molecule



Radical Chain Polymerization



K_p: rate of propagation



K_{t,O₂}: rate of termination

Photo initiator

Radicals

Monomer Double bond

Oxygen

rate

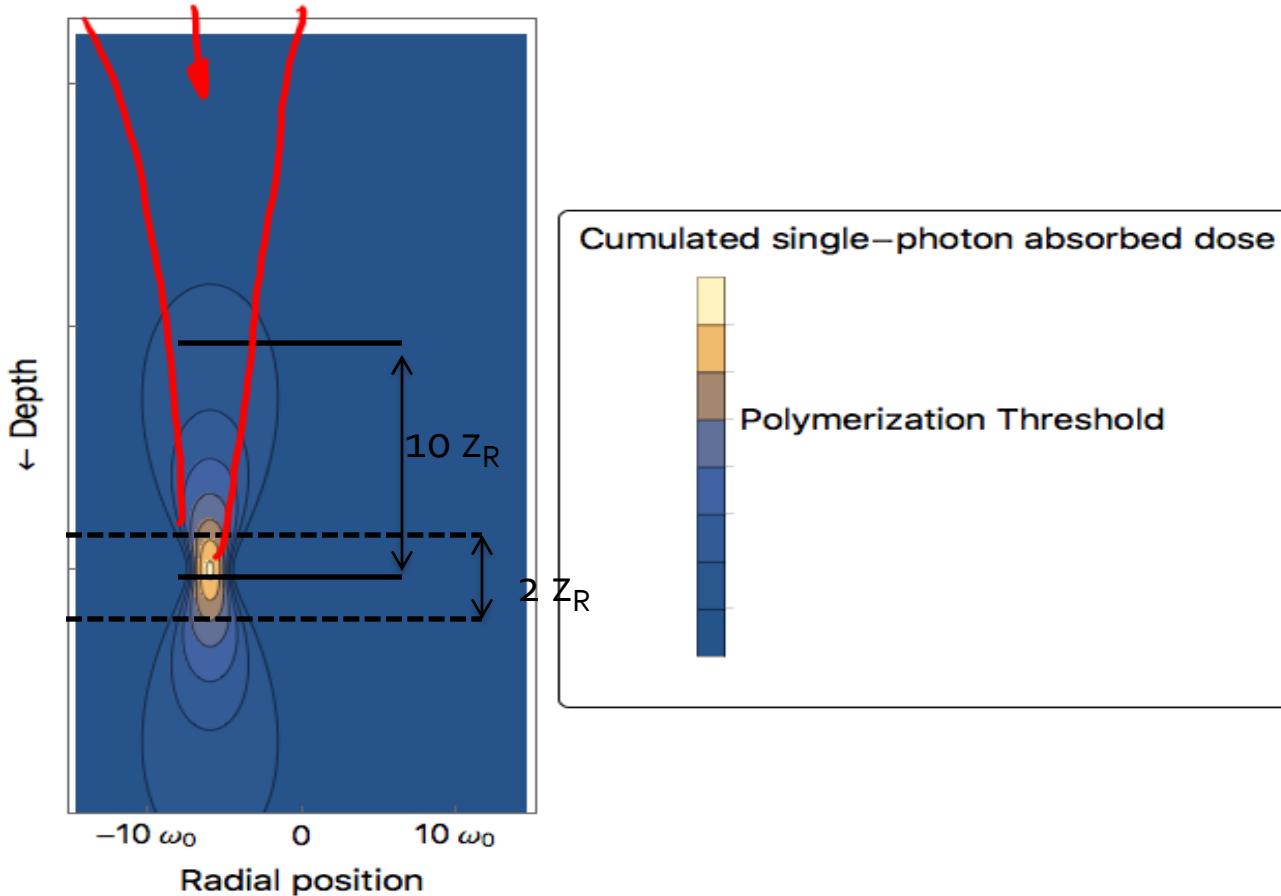
$$\frac{d[\text{In}]}{dt} = -k_d \cdot \frac{P}{\text{area}} \cdot [I^{(2)}] \cdot [\text{In}]$$

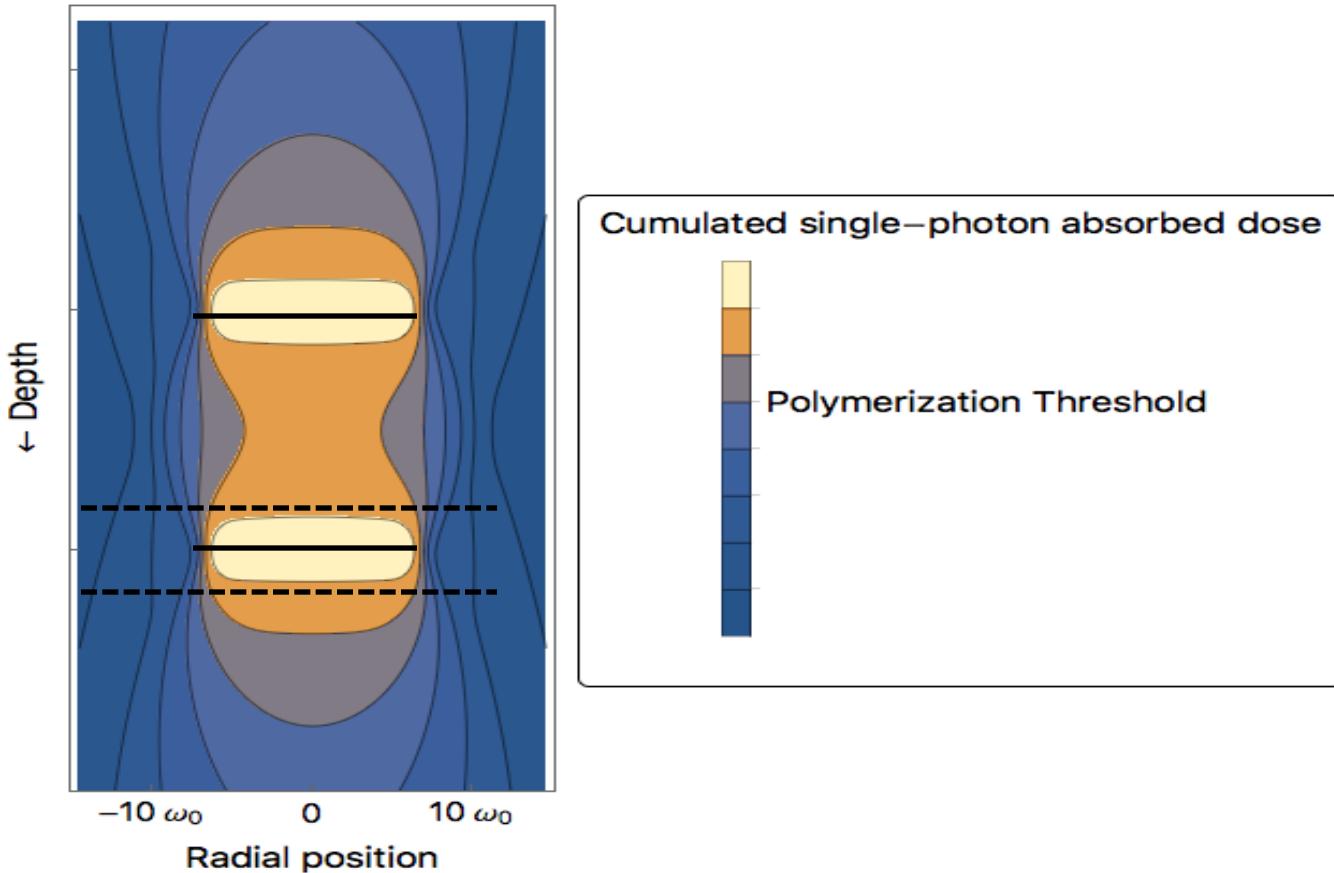
$$\frac{d[R\cdot]}{dt} = + \underbrace{2k_d I^{(2)} [\text{In}]}_{\text{generation}} - [O_2] [R\cdot] \cdot k_{O_2} - 2k_t [R\cdot]^2$$

$$\boxed{\frac{d[\text{DB}]}{dt} = -k_p [\text{DB}] [R\cdot]}$$

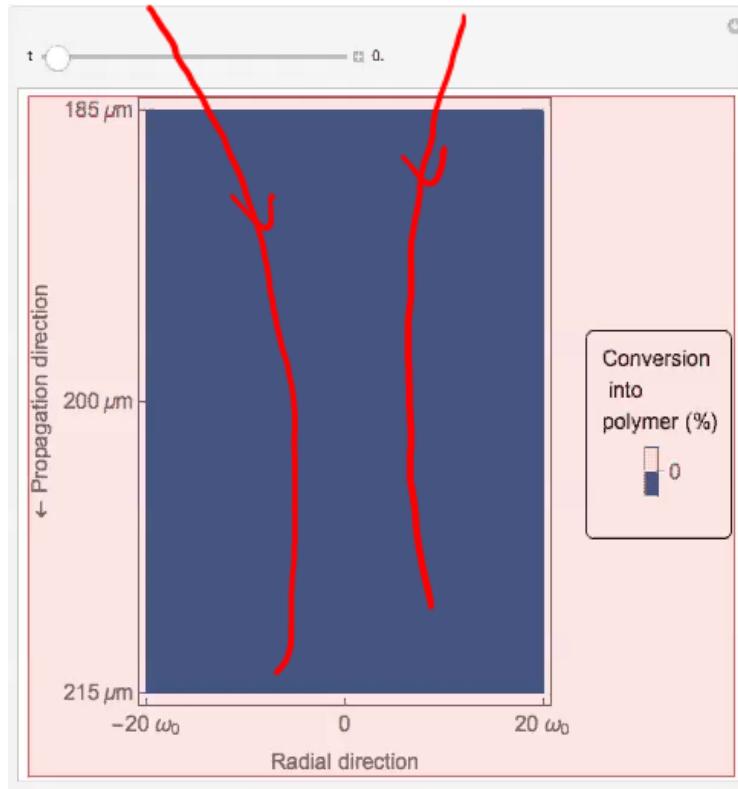
$$\frac{d[O_2]}{dt} = -k_{O_2} [R\cdot] [O_2] + D_{O_2} \frac{\partial [O_2]}{\partial z} \text{diffusion}$$

Linear absorption and photopolymerization

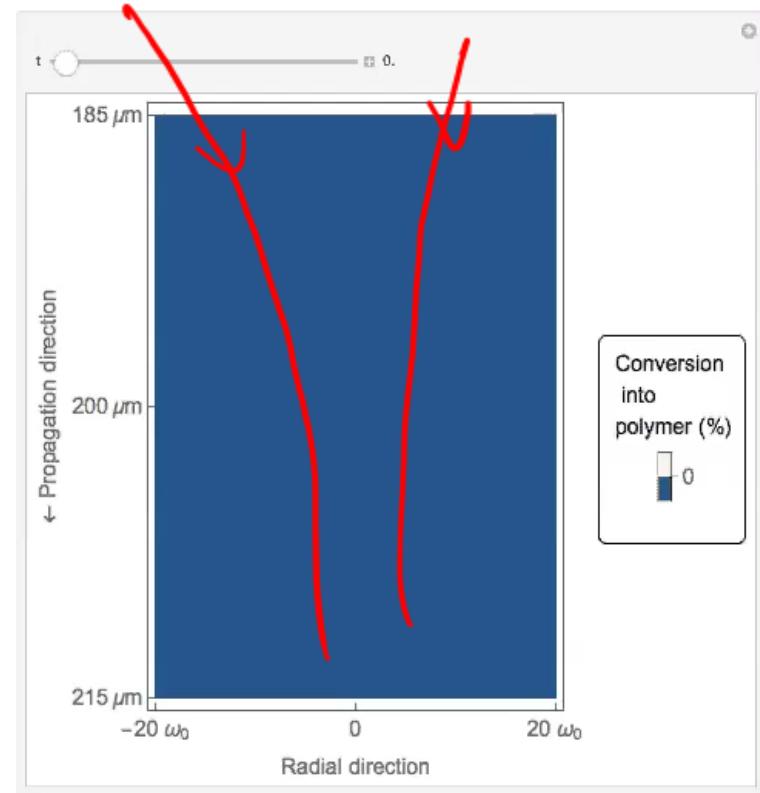




Simulation without oxygen inhibition

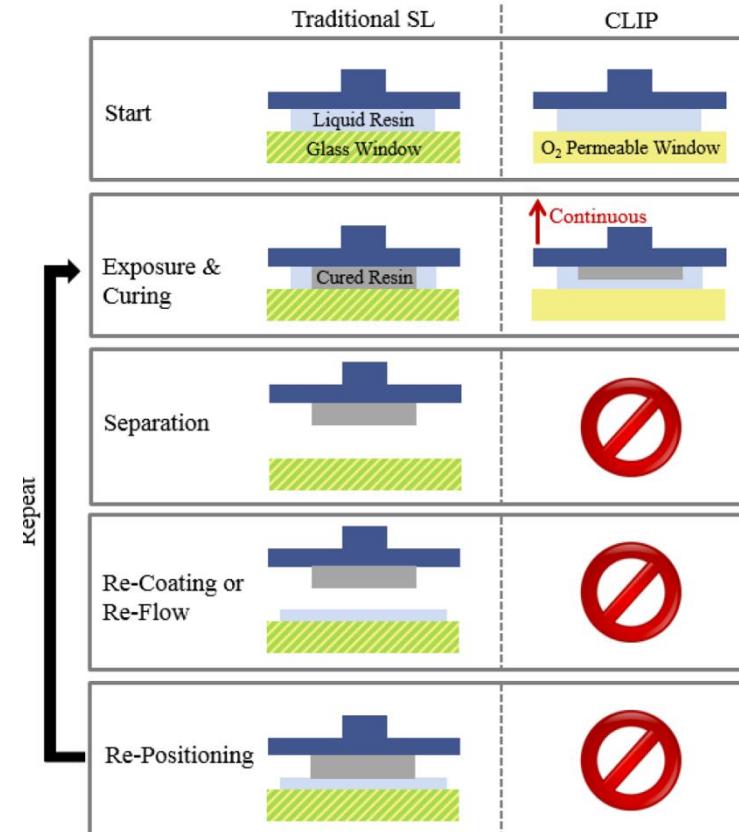
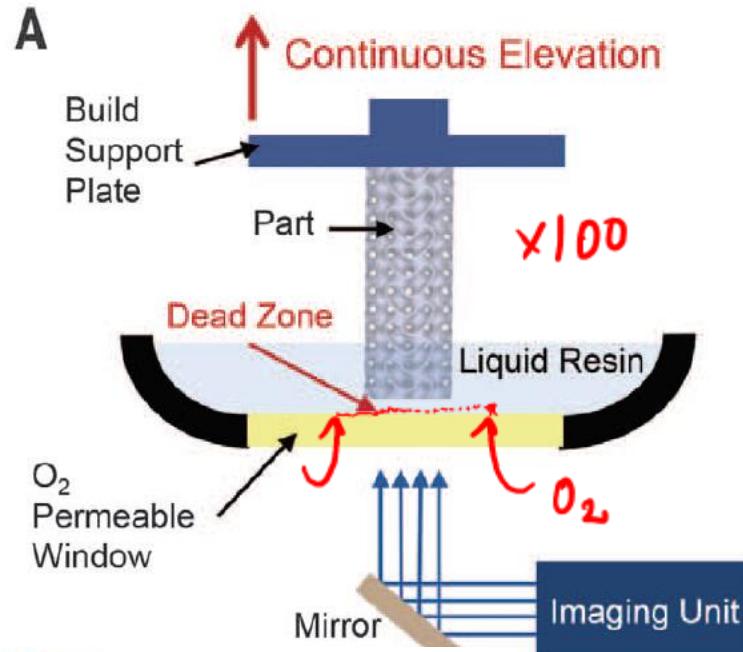


Simulation with oxygen inhibition

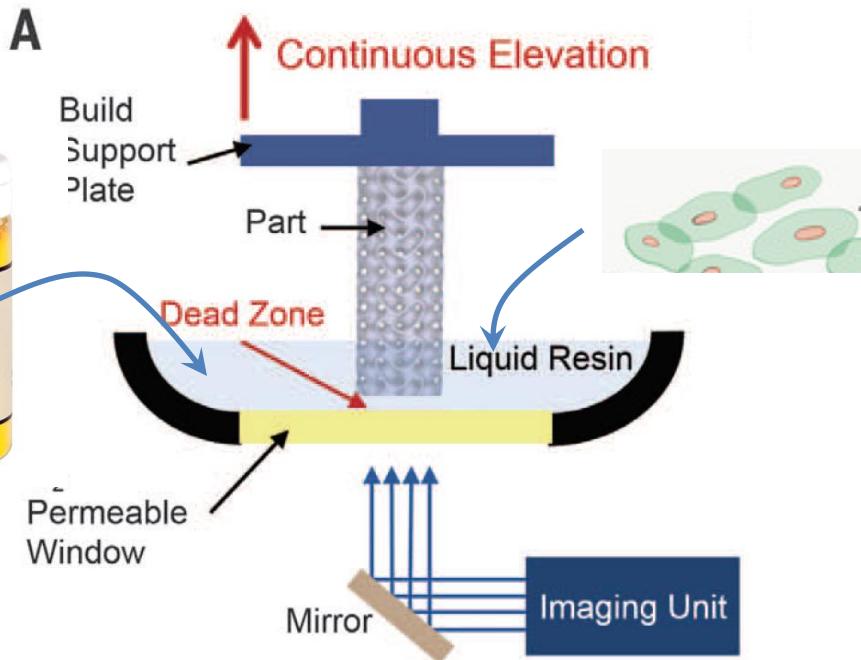


Continuous liquid interface production (CLIP)

EPFL



<https://www.carbon3d.com/our-technology/>



Projection Stereolithography

Advanced additive manufacturing technologies – week 6, 2025

